

L Number	Hits	Search Text	DB	Time stamp
-	2	6020637.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/03/04 06:59
-	1265	257/738.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 08:19
-	1520	257/737.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 08:43
-	907	257/678.ccls. and ((central adj opening) or recess or groove or cavity or opening)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 09:44
-	0	6207467.pn. and stiffener	IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 09:58
-	0	6528869.pn. and stiffener	IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 09:48
-	0	6617193.pn. and stiffener	IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 09:48
-	0	6207467.pn. and (bga or (ball adj grid adj array))	IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 09:51
-	10	(bonding adj ring) and stiffener	IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 10:00
-	643	257/\$.ccls. and stiffener	IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 10:16
-	255	438/\$.ccls. and stiffener	IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 10:28
-	58	257/\$.ccls. and (bonding adj ring)	IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 10:19
-	28	438/\$.ccls. and (bonding adj ring)	IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 10:16
-	6	substrate adj coupled adj stiffener	IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/20 10:30

-	1	substrate adj attached adj stiffener	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 10:30
-	715	substrate with stiffener	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 10:36
-	176	(substrate with stiffener) and (recess or recessed or protruding)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 10:42
-	136	(bonding adj ring) and (recess or recessed or protruding)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 10:43
-	0	stiffner adj attached adj substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/03 19:33
-	0	stiffner near substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/03 19:39
-	1	stiffner with substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/03 19:52
-	6	stiffner same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/03 19:31
-	28	stiffener adj attached adj substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/03 19:33
-	243	stiffener near substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/03 19:39
-	724	stiffener with substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/03 19:54
-	324	(stiffener with substrate) and 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/04 09:10
-	2278	(stiffener or (heat adj spreader)) with (opening or recess or groove)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/04 07:02
-	290	((stiffener or (heat adj spreader)) with (opening or recess or groove)) and 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/04 07:26

-	75	((stiffener or (heat adj spreader)) with (opening or recess or groove)) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/04 07:26
-	0	6664617617.pn. and pad	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/04 09:11
-	1	6664617.pn. and pad	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/04 09:44
-	0	6664617.pn. and bga	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/03/04 09:44